EClamp2342N ESD/EMI Protection for Color LCD Interfaces

PROTECTION PRODUCTS - EMIClamp™

Description

The EClamp™2342N is a low pass filter array with integrated TVS diodes. It is designed to suppress unwanted EMI/RFI signals and provide electrostatic discharge (ESD) protection in portable electronic equipment. This state-of-the-art device utilizes solid-state silicon-avalanche technology for superior clamping performance and DC electrical characteristics. They have been optimized for **protection of color LCD panels** in cellular phones and other portable electronics.

The device consists of eight identical circuits comprised of TVS diodes for ESD protection, and a resistor - capacitor network for EMI/RFI filtering. A series resistor value of 100Ω and a capacitance value of 20pF are used to achieve 30dB minimum attenuation from 1GHz to 2.5GHz. Each line features two stages of TVS diode protection. The TVS diodes provide effective suppression of ESD voltages in excess of $\pm 15\text{kV}$ (air discharge) and $\pm 8\text{kV}$ (contact discharge) per IEC 61000-4-2, level 4.

The EClamp2342N is in a 16-pin, 0.5mm pitch QFN package. It measures $3.0 \times 3.0 \times 1.0$ mm. The small package makes it ideal for use in portable electronics such as cell phones, digital still cameras, and PDA's.

Features A Ridirect

- Bidirectional EMI/RFI filter with integrated TVS for ESD protection
- ◆ ESD protection to IEC 61000-4-2 (ESD) Level4, ±15kV (air), ±8kV (contact)
- ◆ Filter performance: 30dB minimum attenuation 1GHz to 2.5GHz
- ◆ TVS working voltage: 5V
- Resistor: 100Ω +/- 15%
 Input Capacitance: 20pF (VR = 0V)
- Protection and filtering for eight lines
- Solid-state technology

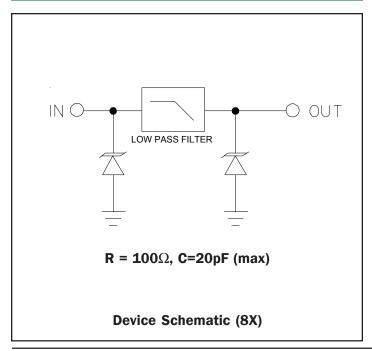
Mechanical Characteristics

- ◆ 16 pin QFN
- ◆ RoHS/WEEE Compliant
- Nominal Dimensions: 3.0 x 3.0 x 1.0 mm
- ◆ Lead Pitch: 0.5mm
- ◆ Lead finish: Matte Tin
- ◆ Marking : Marking Code + Date Code
- Packaging: Tape and Reel per EIA 481

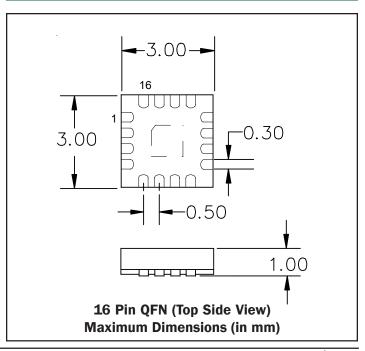
Applications

- Color LCD Panel Protection
- Cell Phone CCD Camera Lines
- Clamshell Cell Phones
- Personal Digital Assistants (PDA's)

Circuit Diagram



Package Configuration





Maximum Ratings

| Rating | Symbol | Value | Units |
|--|------------------|------------------|-------|
| ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact) | V _{ESD} | +/- 17 +/- 12 | kV |
| Junction Temperature | T _J | 125 | °C |
| Operating Temperature | T _{op} | -40 to +85 | |
| Storage Temperature | T _{STG} | -55 to +150 | °C |

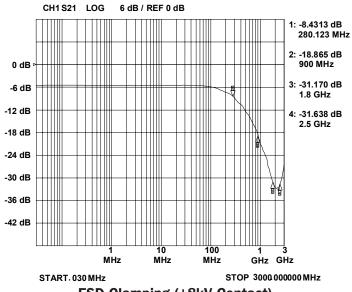
Electrical Characteristics

| Parameter | Symbol | Conditions | Minimum | Typical | Maximum | Units |
|-------------------------------|------------------|---|---------|---------|---------|-------|
| TVS Reverse Stand-Off Voltage | V _{RWM} | | | | 5 | V |
| TVS Reverse Breakdown Voltage | $V_{_{BR}}$ | I _t = 1mA | 6 | 8 | 10 | V |
| TVS Reverse Leakage Current | I _R | V _{RWM} = 3.0V | | | 0.5 | μΑ |
| Total Series Resistance | R | Each Line | 85 | 100 | 115 | Ohms |
| Total Capacitance | C _{in} | Input to Gnd, Each Line V _R = OV, f = 1MHz | | 16 | 20 | pF |
| Total Capacitance | C _{in} | Input to Gnd, Each Line V _R = 2.5V, f = 1MHz | | 12 | | pF |

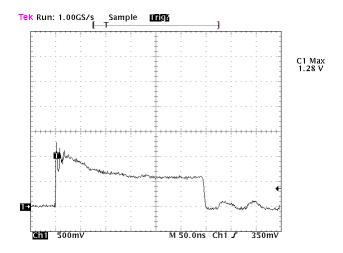


Typical Characteristics

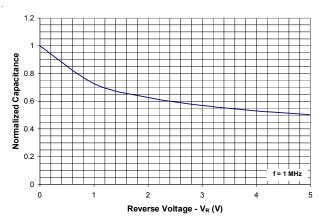
Typical Insertion Loss S21 (Each Line)



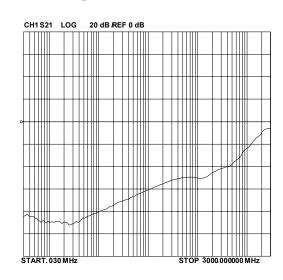
ESD Clamping (+8kV Contact)



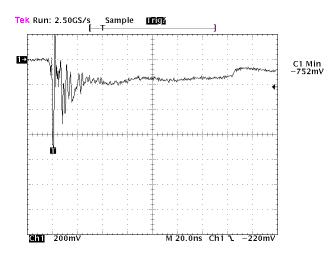
Capacitance vs. Reverse Voltage (Normalized to 0 volts)



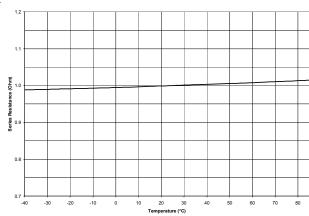
Analog Crosstalk (Each Line)



ESD Clamping (-8kV Contact)



Series Resistance vs. Temperature (Normalized to 25 Degrees Celcius)





Applications Information

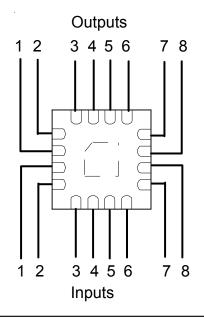
Device Connection

The EClamp2342N is comprised of eight identical circuits each consisting of a low pass filter for EMI/RFI suppression and dual TVS diodes for ESD protection. The device is housed in a 16-pin Quad Flat No-Lead (QFN) package. Electrical connection is made via 16 pins located at the bottom of the device. A center tab serves as the ground connection. Pin connections are noted in the table to the right. The device is symmetrical and designed for easy PCB routing as shown in the layout example below. All path lengths should be kept as short as possible to minimize the effects of parasitic inductance in the board traces.

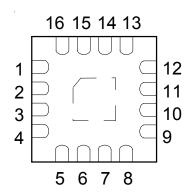
Matte Tin Lead Finish

Matte tin has become the industry standard lead-free replacement for SnPb lead finishes. A matte tin finish is composed of 100% tin solder with large grains. Since the solder volume on the leads is small compared to the solder paste volume that is placed on the land pattern of the PCB, the reflow profile will be determined by the requirements of the solder paste. Therefore, these devices are compatible with both lead-free and SnPb assembly techniques. In addition, unlike other lead-free compositions, matte tin does not have any added alloys that can cause degradation of the solder joint.

Layout Example (Top Side View)

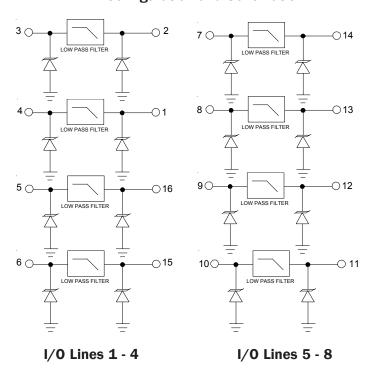


Pin Identification and Configuration (Top Side View)



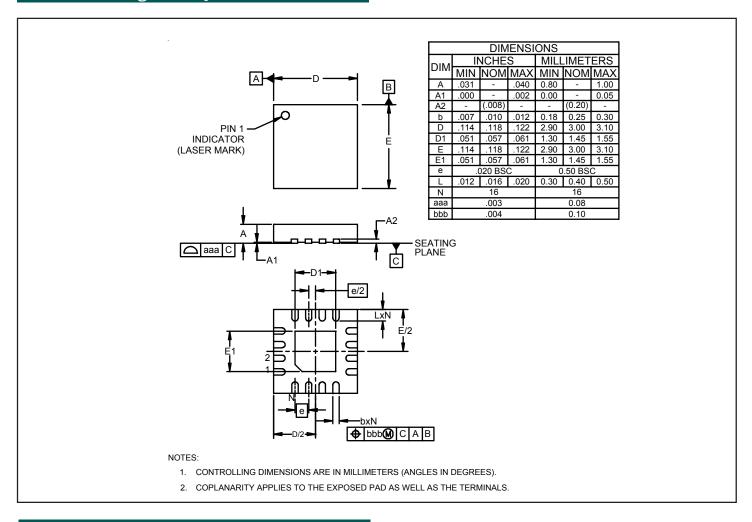
| Pin | Identification | | |
|---------------|-------------------------------------|--|--|
| 3 - 10 | Input, Lines 1, 2, 3, 4, 5, 6, 7, 8 | | |
| 1, 2, 11 - 16 | Output Lines 1, 2, 3, 4, 5,6, 7, 8 | | |
| Center Tab | Ground | | |

Pin Configuration and Schematic

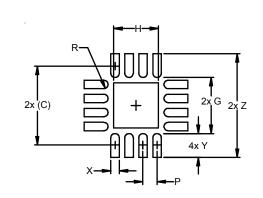




Outline Drawing - 16L QFN



Land Pattern - 16L QFN



| DIMENSIONS | | | |
|------------|--------------------|--------|--|
| DIM | INCHES MILLIMETERS | | |
| С | (.112) | (2.85) | |
| G | .079 | 2.00 | |
| Η | .063 | 1.60 | |
| R | .006 | 0.15 | |
| Р | .020 | 0.50 | |
| Χ | .012 | 0.30 | |
| Υ | .033 | 0.85 | |
| Z | .146 | 3.70 | |

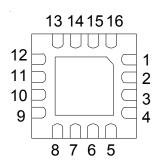
NOTES:

THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY.
CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR
COMPANY'S MANUFACTURING GUIDELINES ARE MET.



Marking

16 15 14 13 1 2342N 12 10 12 11 10 10 10 10 10 9



Top View Showing Device Marking

Bottom View Showing Pin 1 Identifier

Ordering Information

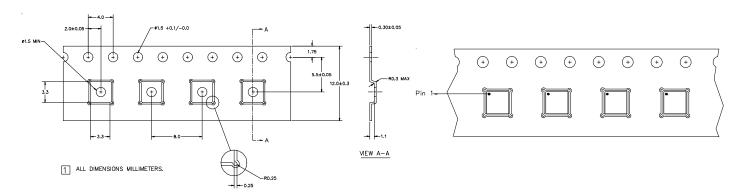
| Part Number | Qty per Reel | Reel Size |
|-----------------|-----------------|-----------|
| EClamp2342N.TCT | 3000 | 7 Inch |

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Notes:

- 1) YYWW = Date Code (example: 0410 = 2004 year
- Week 10
- 2) Pin 1 indicated by bevel on the ground pad

Tape and Reel Specification



Tape Specifications

Device Orientation in Tape

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P6KE8.2A SA110CA SA60CA SA64CA SMBJ12CATR SMBJ8.0A SMLJ30CA-TP ESD101-B1-02ELS E6327 ESD112-B1-02EL E6327
ESD119B1W01005E6327XTSA1 ESD5V0L1B02VH6327XTSA1 ESD7451N2T5G 19180-510 CPDT-5V0USP-HF 3.0SMCJ33CA-F
3.0SMCJ36A-F HSPC16701B02TP D3V3Q1B2DLP3-7 D55V0M1B2WS-7 DESD5V0U1BL-7B DRTR5V0U4SL-7 SCM1293A-04SO
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